



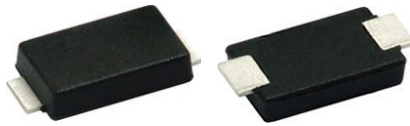
**THE DATASHEET OF  
TA6F15AHM3\_A/H**



# Surface Mount PAR<sup>®</sup> Transient Voltage Suppressors

High Temperature Stability and High Reliability Conditions

## eSMP<sup>®</sup> Series



Top View

Bottom View

### SlimSMA (DO-221AC)

Cathode Anode

## DESIGN SUPPORT TOOLS

[click logo to get started](#)

**3D**  
Models  
Available

PRIMARY CHARACTERISTICS	
$V_{BR}$	6.8 V to 51 V
$V_{WM}$	5.8 V to 43.6 V
$P_{PPM}$ (10 x 1000 $\mu$ s)	600 W
$P_D$ at $T_M = 65$ °C	6 W
$T_J$ max.	185 °C
Polarity	Uni-directional
Package	SlimSMA (DO-221AC)

## FEATURES

- Very low profile - typical height of 0.95 mm
- Junction passivation optimized design passivated anisotropic rectifier technology
- $T_J = 185$  °C capability suitable for high reliability and automotive requirement
- Ideal for automated placement
- Uni-directional only
- Excellent clamping capability
- Peak pulse power: 600 W (10/1000  $\mu$ s)
- AEC-Q101 qualified
- ESD capability: IEC 61000-4-2 level 4
  - 15 kV (air)
  - 8 kV (contact)
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units for consumer, computer, industrial, and telecommunication.

## MECHANICAL DATA

### Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/NHM3\_X - halogen-free, RoHS-compliant and AEC-Q101 qualified (“\_X” denotes revision code e.g. A, B,....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power dissipation with a 10/1000 $\mu$ s waveform	$P_{PPM}$ <sup>(1)</sup>	600	W
Peak pulse current with a 10/1000 $\mu$ s waveform	$I_{PPM}$ <sup>(1)</sup>	See next table	A
Power dissipation on infinite heat sink, $T_M = 65$ °C	$P_D$ <sup>(2)</sup>	6	W
Power dissipation, $T_M = 25$ °C	$P_D$ <sup>(3)</sup>	1.1	
Operating junction and storage temperature range	$T_J, T_{STG}$	-65 to +185	°C

## Notes

- (1) Non-repetitive current pulse, per fig. 3 and derated above  $T_A = 25$  °C per fig. 2.
- (2) Power dissipation mounted on infinite heat sink
- (3) Power dissipation mounted on minimum recommended pad layout



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)											
DEVICE TYPE	DEVICE MARKING CODE	BREAKDOWN VOLTAGE $V_{BR}^{(1)}$ AT $I_T$ (V)			TEST CURRENT $I_T$ (mA)	STAND-OFF VOLTAGE $V_{WM}$ (V)	MAXIMUM REVERSE LEAKAGE AT $V_{WM}$ $I_R$ ( $\mu\text{A}$ )	$T_J = 150\text{ }^\circ\text{C}$ MAXIMUM REVERSE LEAKAGE AT $V_{WM}$ $I_R$ ( $\mu\text{A}$ )	MAXIMUM PULSE SURGE CURRENT $I_{PPM}$ (A)	MAXIMUM CLAMPING VOLTAGE AT $I_{PPM}$ $V_C$ (V)	TYPICAL TEMP. COEFFICIENT OF $V_{BR}^{(2)}$ $\alpha_T$ ( $\%/\text{ }^\circ\text{C}$ )
		MIN.	NOM.	MAX.							
TA6F6.8A	AEP	6.45	6.80	7.14	10	5.80	500	1000	57.1	10.5	0.047
TA6F7.5A	AGP	7.13	7.50	7.88	10	6.40	250	500	53.1	11.3	0.052
TA6F8.2A	AKP	7.79	8.20	8.61	10	7.02	100	200	49.6	12.1	0.056
TA6F9.1A	AMP	8.65	9.10	9.55	1.0	7.78	25	50	44.8	13.4	0.060
TA6F10A	APP	9.5	10.0	10.5	1.0	8.55	5.0	20	41.4	14.5	0.064
TA6F11A	ARP	10.5	11.0	11.6	1.0	9.40	2.0	5.0	38.5	15.6	0.067
TA6F12A	ATP	11.4	12.0	12.6	1.0	10.2	2.0	5.0	35.9	16.7	0.070
TA6F13A	AVP	12.4	13.0	13.7	1.0	11.1	2.0	5.0	33.0	18.2	0.072
TA6F15A	AXP	14.3	15.0	15.8	1.0	12.8	1.0	5.0	28.3	21.2	0.076
TA6F16A	AZP	15.2	16.0	16.8	1.0	13.6	1.0	5.0	26.7	22.5	0.078
TA6F18A	BEP	17.1	18.0	18.9	1.0	15.3	1.0	5.0	23.5	25.5	0.080
TA6F20A	BGP	19.0	20.0	21.0	1.0	17.1	1.0	5.0	21.7	27.7	0.082
TA6F22A	BKP	20.9	22.0	23.1	1.0	18.8	1.0	5.0	19.6	30.6	0.084
TA6F24A	BMP	22.8	24.0	25.2	1.0	20.5	1.0	5.0	18.1	33.2	0.085
TA6F27A	BPP	25.7	27.0	28.4	1.0	23.1	1.0	5.0	16.0	37.5	0.087
TA6F30A	BRP	28.5	30.0	31.5	1.0	25.6	1.0	5.0	14.5	41.4	0.088
TA6F33A	BTP	31.4	33.0	34.7	1.0	28.2	1.0	5.0	13.1	45.7	0.089
TA6F36A	BVP	34.2	36.0	37.8	1.0	30.8	1.0	5.0	12.0	49.9	0.090
TA6F39A	BXP	37.1	39.0	41.0	1.0	33.3	1.0	5.0	11.1	53.9	0.091
TA6F43A	BZP	40.9	43.0	45.2	1.0	36.8	1.0	10.0	10.1	59.3	0.092
TA6F47A	CEP	44.7	47.0	49.4	1.0	40.2	1.0	10.0	9.3	64.8	0.092
TA6F51A	CGP	48.5	51.0	53.6	1.0	43.6	1.0	10.0	8.6	70.1	0.093

**Notes**

- (1) Pulse test:  $t_p \leq 50\text{ ms}$
- (2) To calculate  $V_{BR}$  vs. junction temperature, use the following formula:  $V_{BR}$  at  $T_J = V_{BR}$  at  $25\text{ }^\circ\text{C} \times (1 + \alpha_T \times (T_J - 25))$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Typical thermal resistance, junction to ambient	$R_{\theta JA}^{(1)}$	145	$^\circ\text{C/W}$
Typical thermal resistance, junction to mount	$R_{\theta JM}^{(2)}$	20	$^\circ\text{C/W}$

**Notes**

- (1) Mounted on minimum recommended pad layout
- (2) Mounted on infinite heat sink

<b>IMMUNITY TO STATIC ELECTRICAL DISCHARGE TO THE FOLLOWING STANDARDS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
IEC 61000-4-2	Human body model (contact mode)	$C = 150\text{ pF}$ , $R = 330\text{ }\Omega$	$V_C$	4	$> 8\text{ kV}$
	Human body model (air discharge mode)				$> 15\text{ kV}$

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TA6F6.8AHM3_A/H <sup>(1)</sup>	0.032	H	3500	7" diameter plastic tape and reel
TA6F6.8AHM3_A/I <sup>(1)</sup>	0.032	I	14 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified



**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

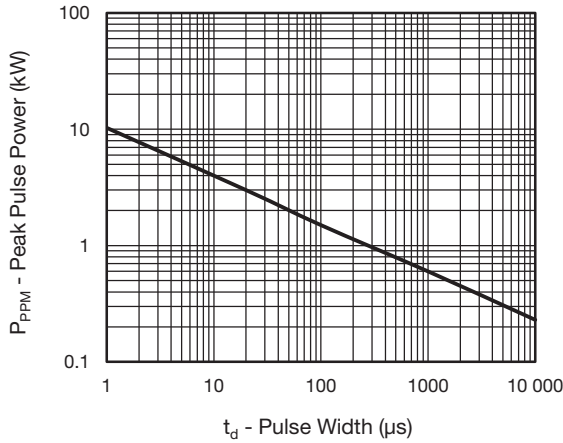


Fig. 1 - Peak Pulse Power Rating Curve

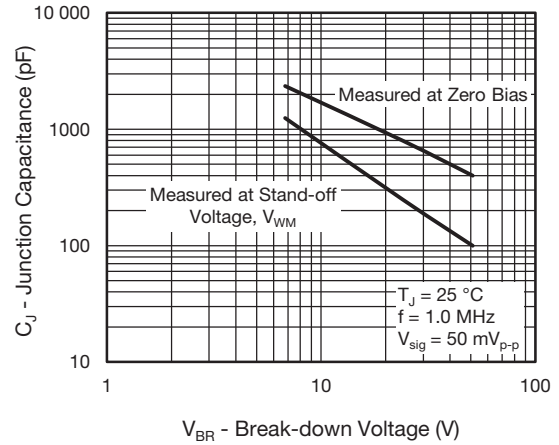


Fig. 4 - Typical Junction Capacitance

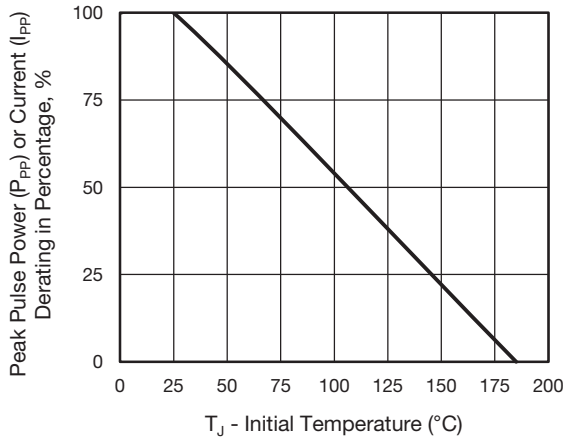


Fig. 2 - Pulse Power or Current vs. Initial Junction Temperature

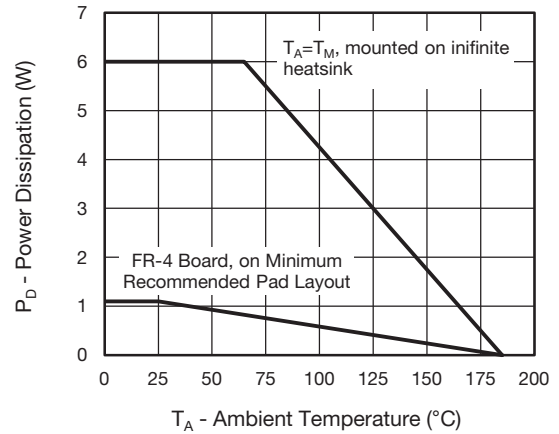


Fig. 5 - Power Dissipation Derating Curve

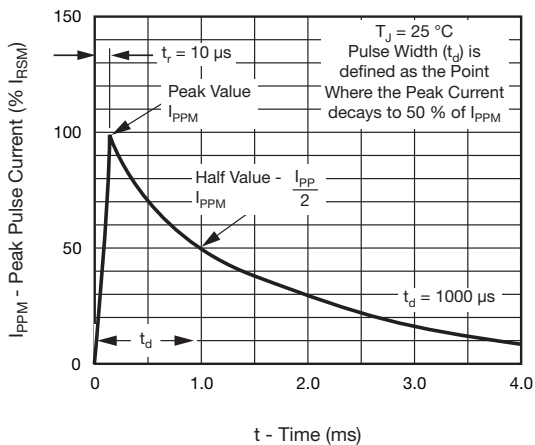


Fig. 3 - Pulse Waveform

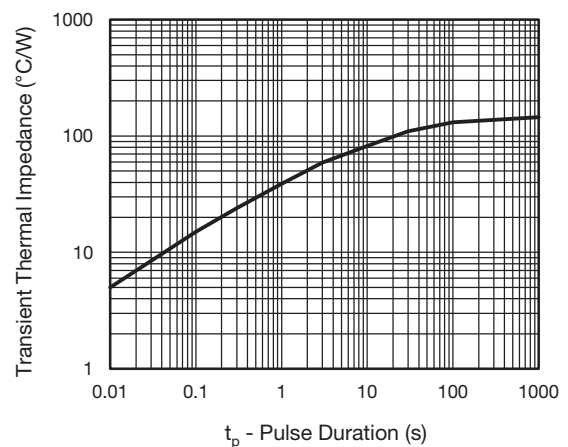


Fig. 6 - Typical Transient Thermal Impedance



## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### SlimSMA (DO-221AC)





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